

09-09-2002

OFFICE OF PUBLIC RECORDS

2002 SEP -3 AM 10:46

RE

102215942

IEET

FINANCE SECTION

PATENTS ONLY

TO: The Commissioner of Patents and Trademarks: Please record the attached original document(s) or copy(ies).

Submission Type

☒ New☐ Resubmission (Non-Recordation)

Document ID#

☐ Correction of PTO Error

Reel #

Frame #

☐ Corrective Document

Reel #

Frame #

Conveyance Type

☒ Assignment☐ Security Agreement☐ License☐ Change of Name☐ Merger☐ Other

U.S. Government

(For Use ONLY by U.S. Government Agencies)

☐ Departmental File☐ Secret File

Conveying Party(ies)

☒ Mark if additional names of conveying parties attached

Name (line 1) Jeon, Chang-ki

Execution Date
Month Day Year
08/09/2002

Name (line 2)

Second Party

Name (line 1) Kim, Sung-lyong

Execution Date
Month Day Year
08/09/2002

Name (line 2)

Receiving Party

☐ Mark if additional names of receiving parties attached

Name (line 1) Fairchild Korea Semiconductor, Ltd.

Name (line 2)

Address (line 1) (420-711) 82-3 Todang-Dong, Wonmi-District

Address (line 2)

Address (line 3) Bucheon City

Kyonggi Province, KOREA

420-711

City

State/Country

Zip Code

☐ If document to be recorded is an assignment and the receiving party is not domiciled in the United States, an appointment of a domestic representative is attached. (Designation must be a separate document from Assignment.)

Domestic Representative Name and Address

Enter for the first Receiving Party only.

Name

Address (line 1)

Address (line 2)

Address (line 3)

Address (line 4)

09/06/2002 LNUELLER 00000130 10123007

FOR OFFICE USE ONLY

01 FC:581

40.00 OP

Correspondent Name and Address

Area Code and Telephone Number

(585) 454-2250

Name Thomas R. FitzGerald, Esq.

Address (line 1) 16 E. Main St., Suite 210

Address (line 2) Rochester, New York 14614-1803

Address (line 3)

Address (line 4)

Pages

Enter the total number of pages of the attached conveyance document including any attachments.

2

Application Number(s) or Patent Number(s)

☐ Mark if additional numbers attached

Enter either the Patent Application Number or the Patent Number (DO NOT ENTER BOTH numbers for the same property).

Patent Application Number(s)

Patent Number(s)

10/123,007

If this document is being filed together with a new Patent Application, enter the date the patent application was

Month Day Year

Patent Cooperation Treaty (PCT)

Enter PCT application number only if a U.S. Application Number has not been assigned.

PCT

PCT

PCT

PCT

PCT

PCT

Number of Properties

Enter the total number of properties involved.

1

Fee Amount

Fee Amount for Properties Listed (37 CFR 3.41): \$

40.00

Method of Payment:

Enclosed ☒

Deposit Account ☐

Deposit Account

(Enter for payment by deposit account or if additional fees can be charged to the

Deposit Account Number:

#

Authorization to charge additional fees:

Yes ☐

No ☐

Statement and Signature

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Charges to deposit account are authorized, as indicated herein.

Thomas R. FitzGerald, Esq.

Name of Person Signing

Signature

Date

FAIRCHILD SEMICONDUCTOR CORPORATION**Assignment**

As a below named inventor or joint inventor of an invention or improvement entitled:

**HIGH VOLTAGE SEMICONDUCTOR DEVICE HAVING
HIGH BREAKDOWN VOLTAGE ISOLATION REGION**

for which I have executed an application for Letters Patent of the United States of America, on an even date herewith; and

WHEREAS, FAIRCHILD KOREA SEMICONDUCTOR, LTD., a Large Entity, organized and existing under the laws of the Republic of Korea, having a principal place of business at (420-711) 82-3 Todang-Dong, Wonmi-District, Bucheon City, Kyonggi Province, Korea, is desirous of obtaining the entire right, title and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I have sold, assigned, transferred, and set over, and by these presents do hereby sell, assign, transfer and set over, unto said FAIRCHILD KOREA SEMICONDUCTOR, LTD., its successors, legal representatives, and assigns, my entire right, title and interest in, to, and under the said invention, and the said application, and all divisional, renewal, substitutional, and continuation applications thereof, and all Letters Patent of the United States of America which may be granted thereof and all reissues and extensions hereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, including all rights of priority, all rights to publish cautionary notices reserving ownership of said invention, all rights to register said invention in appropriate registries, and all Letters Patent which may be granted for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and I hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to said FAIRCHILD KOREA SEMICONDUCTOR, LTD., its successors, legal representatives, and assigns, in accordance with the terms of this instrument.

And I hereby covenant that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

And I hereby further covenant and agree that I will communicate to said FAIRCHILD KOREA SEMICONDUCTOR, LTD., its successors, legal representatives, and assigns, any fact known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisions, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid said FAIRCHILD KOREA SEMICONDUCTOR, LTD., its successors, legal representatives, and assigns, to obtain and enforce proper patent protection for said invention in all countries.

Docket:
90065.026802/17732.37860.00

IN TESTIMONY WHEREOF, I authorize and affirm said assignments with the signature(s) set forth below on the indicated date(s).

Inventors:

<u>Chang-ki Jeon</u> Chang-ki Jeon	<u>2002.08.09</u> Date
<u>Sung-lyong Kim</u> Sung-lyong Kim	<u>2002.08.09</u> Date
<u>Jongjib Kim</u> Jong-jib Kim	<u>2002.08.09</u> Date

00000871.rtf

CERTIFICATE OF MAILING BY FIRST CLASS MAIL (37 CFR 1.8)Applicant(s): **Chang-ki Jeon, et al.**

Docket No.

90065.026802/17732.37860.00

Serial No.

10/123,007

Filing Date

April 15, 2002

Examiner

Unknown

Group Art Unit

2811Invention: **HIGH VOLTAGE SEMICONDUCTOR DEVICE HAVING HIGH BREAKDOWN VOLTAGE ISOLATION REGION**I hereby certify that this **Recordation Form Cover Sheet with Signed Assignment & Form PTO-2038**
(Identify type of correspondence)

is being deposited with the United States Postal Service as first class mail in an envelope addressed to: The

Assistant Commissioner for Patents, Washington, D.C. 20231 on

August 29, 2002

(Date)

Penny P. Clements

(Typed or Printed Name of Person Mailing Correspondence)



(Signature of Person Mailing Correspondence)

Note: Each paper must have its own certificate of mailing.